Call for Papers
The 2nd IEEE International Conference on Telecommunications and Photonics (ICTP) 2017
December 26-28, 2017
Dept. of EEE, Bangladesh University of Engineering and Technology (BUET)
Dhaka, Bangladesh
Website: www.ictp-comsoc.org, Email: info@ictp-comsoc.org

The IEEE International Conference on Telecommunications and Photonics (ICTP) is the second specialized conference on Communication Engineering and Photonics in Bangladesh which will be organized by IEEE ComSoc Bangladesh Chapter. ICTP will bring together individuals from academia, research organizations and industry of worldwide to discuss and share ideas, and to present their latest findings and experiences in the areas of Telecommunication Engineering and Photonics. Prospective authors are invited to submit original technical papers for presentation at the conference. The presented papers will be available in the IEEE Xplore.

Scope of the Conference

- Ad-hoc and Sensor Networks
- Biomedical Signal Processing
- Big Data
- Cognitive Radio and Software Defined Radio
- Computer Networks
- D2D Communications
- Green Communications
- Internet and Web Applications
- Internet of Things
- Mobile Communications (4G/5G)
- Multimedia Communications
- Multimedia Systems and Applications
- Microwave and Radar Engineering
- Millimeter Wave Communication
- Next Generation Wireless Networks
- Optical Communications
- Optical Networks
- RF and Wireless Communication Systems
- RFID Technology and Applications
- Smart-Grid Communication
- Satellite and Space Communication
- Terahertz Communication
- Vehicular Networks
- Wireless Robotics
- Wireless Emergency and Security Systems
- Biophotonics
- Displays and Lighting
- Guided Wave Photonics
- Graphene Photonics
- Microwave Photonics
- Nonlinear and Ultrafast Optics
- Nano-Photonics
- Optical Interconnects
- Optical Waveguides
- Optical Energy Harvesting
- Optical micro/nano Resonators and Devices
- Optical Sensors
- Photonic Integration and Packaging
- Photonic Materials and Metamaterials
- Photonic Crystal Devices
- Photodetectors
- Sensors, Systems and Imaging
- Plasmonics
- Silicon Photonics
- Solid State and Semiconductor Lasers
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- Plasmonics
- Silicon Photonics
- Solid State and Semiconductor Lasers

Important Dates
Paper Submission: Aug. 31, 2017
Notification of Acceptance: Oct. 30, 2017
Camera Ready Submission: Nov. 15, 2017
Registration: Dec. 01, 2017

Call for Tutorials:
Submission of Proposals: Oct. 15, 2017

Registration
Local Author (Non-IEEE Member): 6000 BDT
Local Author (IEEE Member): 5000 BDT
International Author (Non-IEEE Member): 300 USD
International Author (IEEE Member): 250 USD
SAARC Author (Non-IEEE Member): 200 USD
SAARC Author (IEEE Member): 150 USD
Local Student Author (Non-IEEE Member): 4000 BDT
Local Student Author (IEEE Member): 3000 BDT
Int. Student Author: 150 USD
Participant: 6000 BDT

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